| Material Composition Declaration Ocopyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions. |                |                          |                        | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |   |                     |                        |                    |                                 |                                 |      |           |  |
|--|----------------|--------------------------|------------------------|---|---|---------------------|------------------------|--------------------|---------------------------------|---------------------------------|------|-----------|--|
|  |                |                          |                        | Form Type<br>Distribute   | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg In |                     |                        |                    |                                 | Afg Information                 | on   |           |  |
| Supplier Information   |                |                          |                        |   |   |                     |                        |                    |                                 |                                 |      |           |  |
| Company name* Compa  |                |                          | ompany unique ID       |   |   | Unique ID Authority |                        |                    |                                 | Response Date*                  |      |           |  |
| onsemi   |                |                          |                        |   |   |                     |                        |                    |                                 | 2024-05-19                      |      |           |  |
| Contact Name Title - Contact   |                |                          | et                     |   |   | Phone - Contact*    |                        |                    | Email                           | Email - Contact*                |      |           |  |
| Product-Env-Stewards Product Envi  |                |                          | nviro Compliance       |   | NA  |                     |                        | Produ              | Product-Env-Stewards@onsemi.com |                                 |      |           |  |
| Authorized Representative* Title - Represent   |                |                          | sentative              |   | Phone - Representative*   |                     |                        | Email              | Email - Representative*         |                                 |      |           |  |
| Product-Env-Stewards Product I   |                |                          | duct Enviro Compliance |   |   | NA                  |                        |                    | Produ                           | Product-Env-Stewards@onsemi.com |      |           |  |
| Requester Item Number  | Mfr Item       | Number                   | Mfr Item Name          |   |   | Effective Date      | Version                | Manufacturing Site | Manufacturing Site              |                                 | UOM  | Unit Type |  |
|  | FL5150N        | 150MX AC Dimmer Cntlr fo |                        | for 50Hz  |   | 2024-05-19          |                        | TAD                |                                 | 77.8214                         | mg   | Each      |  |
| Manufacturing Proccess Informa   | ntion          |                          | ·                      |   |   |                     |                        |                    |                                 |                                 |      |           |  |
| Terminal Plating / Grid Array Material Terminal Base A   |                | Alloy J                  | -STD-020 MSL           | Rating  | Peak Proce  | ss Body Tempe       | rature Max Time at Pea | k Tempera          | ature Numbe                     | er of Reflow Cy                 | cles |           |  |
| Matte Tin (Sn) - annealed CU Alloy   |                | 1                        | 1                      |   | 260   | С                   | 30                     | seco               | onds 3                          |                                 |      |           |  |
| Comments   |                |                          |                        |   |   |                     |                        |                    |                                 |                                 |      |           |  |
| evel 1 - maximum time at peak temperat   | ure during sol | Idering is 10-3          | 0 seconds              |   |   |                     |                        |                    |                                 |                                 |      |           |  |
| or more information regarding materia  | l composition  | please refer to          | page 3                 |   |   |                     |                        |                    |                                 |                                 |      |           |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight  | Unit of Measure | Level    | Substance               | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|---------|-----------------|----------|-------------------------|------------------|--------|---------|-----------------|
| Die                  | 1.43    | mg              | Supplier | Silicon (Si)            | 7440-21-3        |        | 1.43    | mg              |
| Die Attach           | 0.0631  | mg              |          | Epoxy resin             | proprietary data |        | 0.0063  | mg              |
|                      |         |                 | Supplier | Silver (Ag)             | 7440-22-4        |        | 0.0505  | mg              |
|                      |         |                 | Supplier | Formaldehyde Polymer    | 9003-36-5        |        | 0.0063  | mg              |
| Lead Frame           | 25.2775 | mg              | Supplier | Silver (Ag)             | 7440-22-4        |        | 0.0202  | mg              |
|                      |         |                 | Supplier | Zinc (Zn)               | 7440-66-6        |        | 0.0506  | mg              |
|                      |         |                 | Supplier | Iron (Fe)               | 7439-89-6        |        | 0.632   | mg              |
|                      |         |                 | Supplier | Copper (Cu)             | 7440-50-8        |        | 24.5494 | mg              |
|                      |         |                 | Supplier | Phosphorus (P)          | 7723-14-0        |        | 0.0253  | mg              |
| Mold Compound-Black  | 48.6018 | mg              |          | Epoxy resin             | proprietary data |        | 3.4021  | mg              |
|                      |         |                 | Supplier | Phenolic Resin          | Proprietary Data |        | 1.4581  | mg              |
|                      |         |                 | Supplier | Silica Amorphous (SiO2) | 7631-86-9        |        | 4.8602  | mg              |
|                      |         |                 | Supplier | Carbon Black (C)        | 1333-86-4        |        | 0.243   | mg              |
|                      |         |                 | Supplier | Fused Silica (SiO2)     | 60676-86-0       |        | 38.6384 | mg              |
| Plating              | 2.37    | mg              | Supplier | Tin (Sn)                | 7440-31-5        |        | 2.37    | mg              |
| Wire Bond - Au       | 0.079   | mg              | Supplier | Gold (Au)               | 7440-57-5        |        | 0.079   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).